### Power Transistors

# Panasonic

# 2SD1773

### Silicon NPN triple diffusion planar type darlington

For midium speed switching

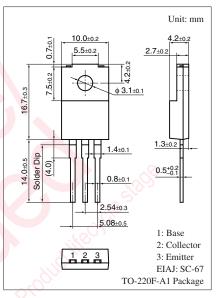
Complementary to 2SB1193

#### Features

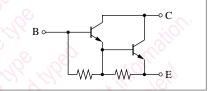
- $\bullet$  High forward current transfer ratio  $h_{FE}$
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	120	v				
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	120	v				
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	7	V				
Collector current	I <sub>C</sub>	8	А				
Peak collector current	I <sub>CP</sub>	12	А				
Collector power	P <sub>C</sub>	50	W				
dissipation $T_a = 25^{\circ}C$		2.0					
Junction temperature	Tj	150	°C				
Storage temperature	T <sub>stg</sub>	-55 to +150	°CO				
			102				





#### Internal Connection

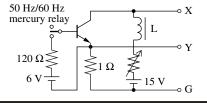


### Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

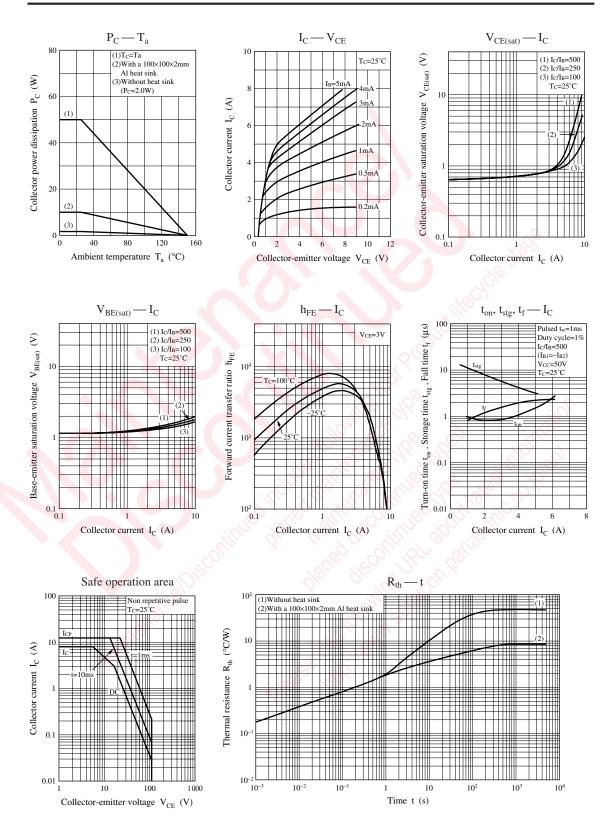
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter sustaining voltage *	V <sub>CEO(SUS)</sub>	$I_{\rm C} = 2 \text{ A}, R_{\rm BE} = \infty, L = 10 \text{ mH}$	120	1.	i i	V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 50 \text{ mA}, I_{\rm C} = 0$	7	SOL		V
Collector-base cutoff current (Emitter open)	І <sub>сво</sub>	$V_{CB} = 120 \text{ V}, I_E = 0$	2 al	0	100	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = 100 \text{ V}, \text{ R}_{BE} = \infty$	20		10	μΑ
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 3 V, I_C = 4 A$	1 000		20000	_
Collector-emitter saturation voltage	V <sub>CE(sat)1</sub>	$I_{\rm C} = 4 \text{ A}, I_{\rm B} = 8 \text{ mA}$			1.5	V
	V <sub>CE(sat)2</sub>	$I_{\rm C} = 8 \text{ A}, I_{\rm B} = 80 \text{ mA}$			3.0	
Base-emitter saturation voltage	V <sub>BE(sat)1</sub>	$I_{\rm C} = 4  {\rm A},  I_{\rm B} = 8  {\rm mA}$			2.0	V
	V <sub>BE(sat)2</sub>	$I_{\rm C} = 8 \text{ A}, I_{\rm B} = 80 \text{ mA}$			3.5	
Transition frequency	f <sub>T</sub>	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 1 \text{ A}, \text{ f} = 1 \text{ MHz}$		20		MHz
Turn-on time	t <sub>on</sub>	$I_{C} = 4 \text{ A}, I_{B1} = 8 \text{ mA}, I_{B2} = -8 \text{ mA},$		0.7		μs
Storage time	t <sub>stg</sub>	$V_{CC} = 50 V$		6.0		μs
Fall time	t <sub>f</sub>			2.0		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: V<sub>CEO(SUS)</sub> Test circuit



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